

MOSFET

OptiMOS[™] 5 Linear FET, 80 V

Features

- Ideal for hot-swap and e-fuse applications
- Very low on-resistance R_{DS(on)}
 Wide safe operating area SOA
 N-channel, normal level

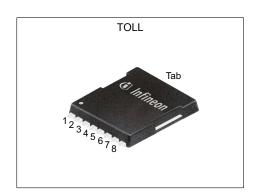
- 100% avalanche tested
- Pb-free plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

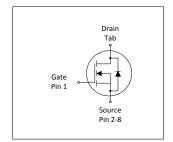
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table : Itoy i oriormanoo i aramotoro								
Parameter	Value	Unit						
$V_{ extsf{DS}}$	80	V						
$R_{DS(on),max}$	1.3	mΩ						
I _D	333	A						
$I_{\text{pulse}} (V_{\text{DS}} = 40 \text{ V}, t_{\text{p}} = 10 \text{ ms})$	13	A						











Type / Ordering Code	Package	Marking	Related Links
IPT013N08NM5LF	PG-HSOF-8	013N08LF	-

OptiMOSTM 5 Linear FET, 80 V



Table of Contents

escription	1
1aximum ratings	3
hermal characteristics	3
lectrical characteristics	4
lectrical characteristics diagrams	6
ackage Outlines	0
evision History	1
rademarks 1	1
nisclaimer	1

OptiMOS[™] 5 Linear FET, 80 V IPT013N08NM5LF



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Oh. a.l		Value	s		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	-	333 210 35	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =10V, T_{A} =25°C, R_{thJA} =40°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1332	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	676	mJ	$I_{\rm D}$ =150 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	278 3.1	W	T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Farameter	Symbol	Min.	Тур.	Max.	Ollit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	0.45	°C/W	-
Device on PCB, 6 cm² cooling area²)	R _{thJA}	-	-	40	°C/W	-
Device on PCB, minimum footprint	R _{thJA}	-	-	62	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

OptiMOS[™] 5 Linear FET, 80 V IPT013N08NM5LF



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	0	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.5	3.3	4.1	V	V _{DS} =V _{GS} , I _D =250 μA
Zero gate voltage drain current	I _{DSS}	-	1 10	10 100	μA	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	2 -2	5 -5	μΑ	V _{GS} =20 V, V _{DS} =0 V V _{GS} =-10 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	1.0	1.3	mΩ	V _{GS} =10 V, I _D =150 A
Gate resistance	R _G	-	52	-	Ω	-
Transconductance	g fs	-	69	-	S	V _{DS} ≥2 I _D R _{DS(on)max} , I _D =150 A

Table 5 **Dynamic characteristics**

Parameter	Or made all		Values			N
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	630	820	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	2000	2600	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	21	37	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	5	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	40	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	33	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	50	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Symbol	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Ollit	Note / Test Condition
Gate to source charge	Q _{gs}	-	5.5	-	nC	V_{DD} =40 V, I_{D} =150 A, V_{GS} =0 to 10 V
Gate to drain charge	Q _{gd}	-	140	-	nC	V _{DD} =40 V, I _D =150 A, V _{GS} =0 to 10 V
Gate charge total	Qg	-	158	-	nC	V _{DD} =40 V, I _D =150 A, V _{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	9	-	V	V _{DD} =40 V, I _D =150 A, V _{GS} =0 to 10 V
Output charge	Qoss	-	185	-	nC	V _{DS} =40 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

OptiMOSTM 5 Linear FET, 80 V

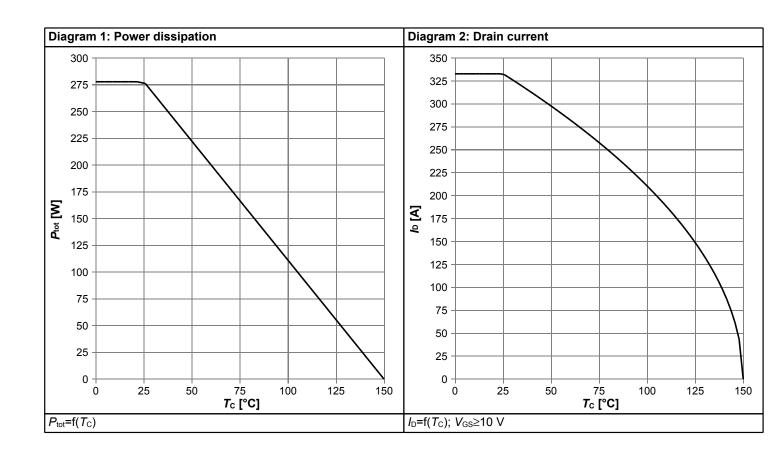


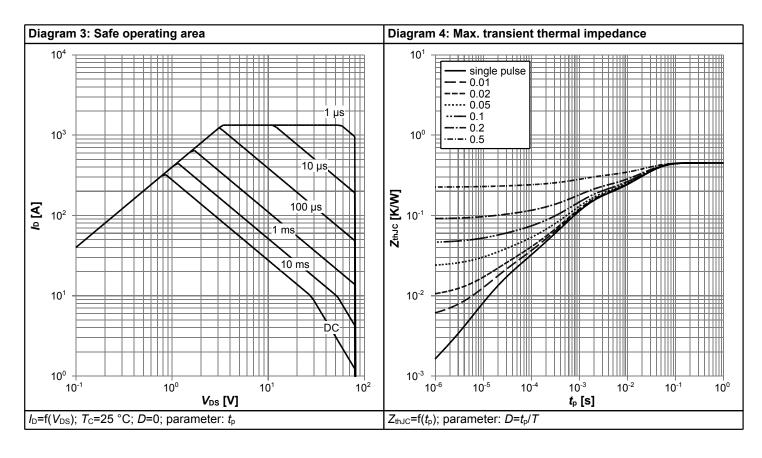
Table 7 Reverse diode

Parameter	Cumbal		Values			Nata (Tanto Carallitian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	255	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1332	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.88	1	V	V _{GS} =0 V, I _F =150 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	44	88	ns	V_R =40 V, I_F =150 A, dI_F/dt =100 A/ μ s
Reverse recovery charge ¹⁾	Qrr	_	210	420	nC	V _R =40 V, I _F =150 A, di _F /dt=100 A/μs

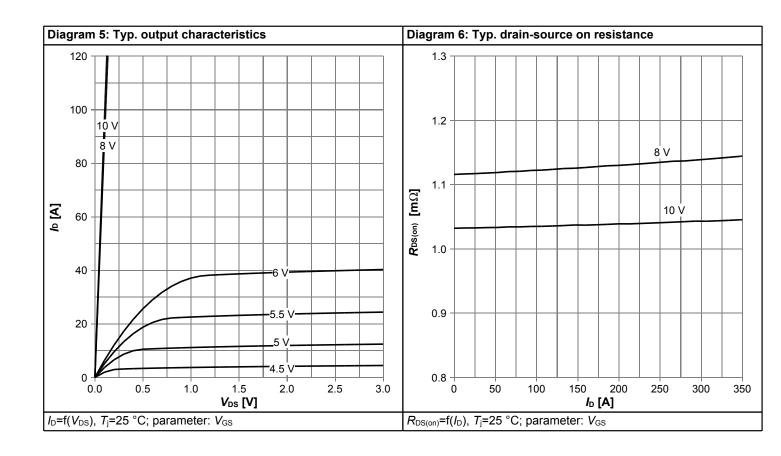


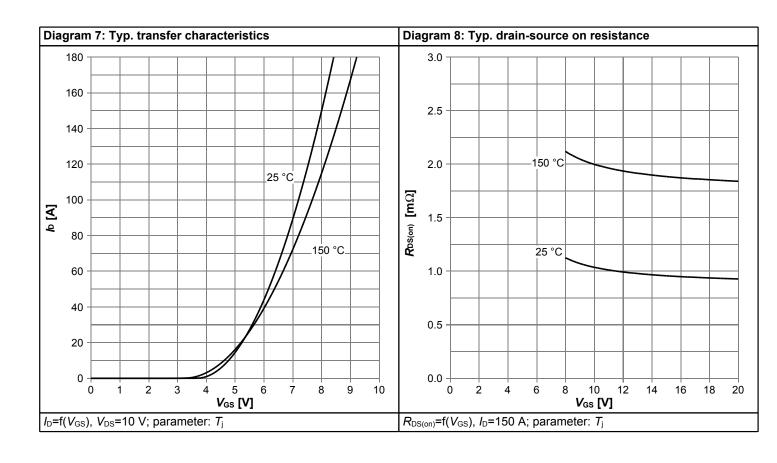
4 Electrical characteristics diagrams



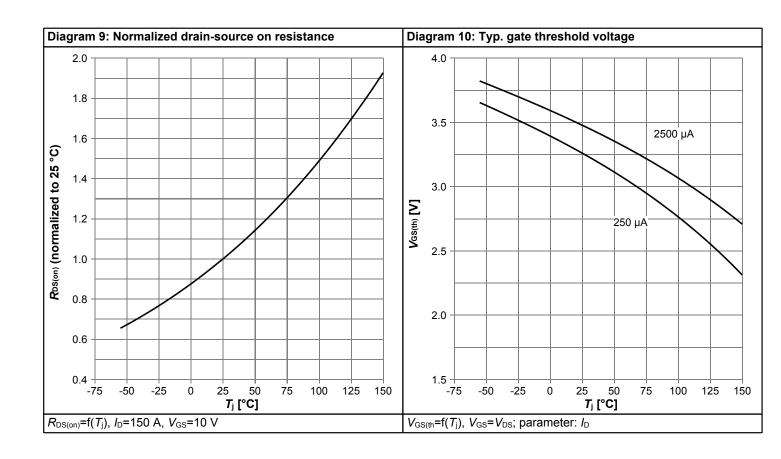


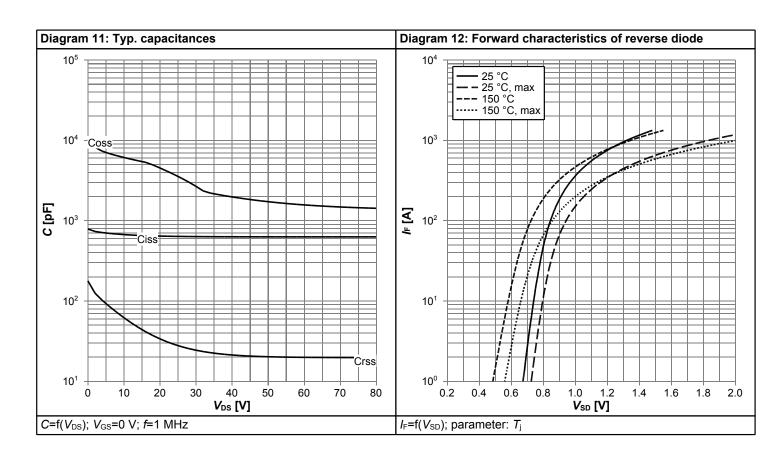




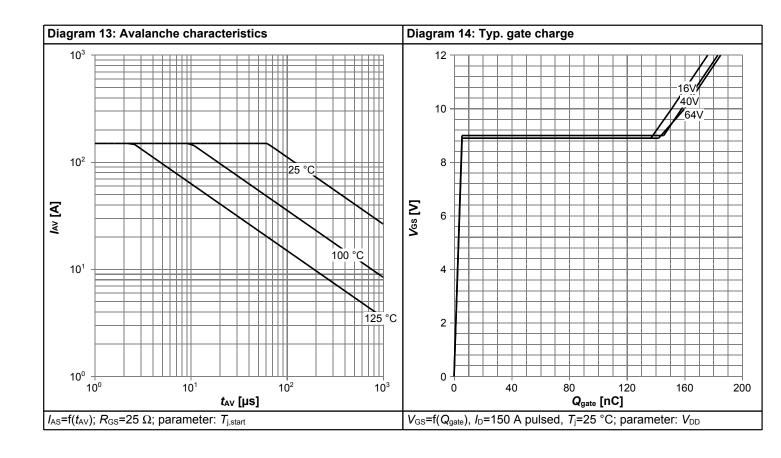


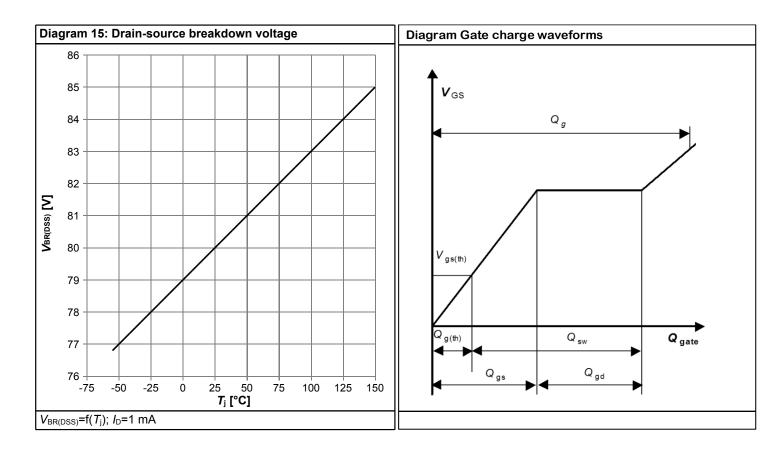














5 Package Outlines

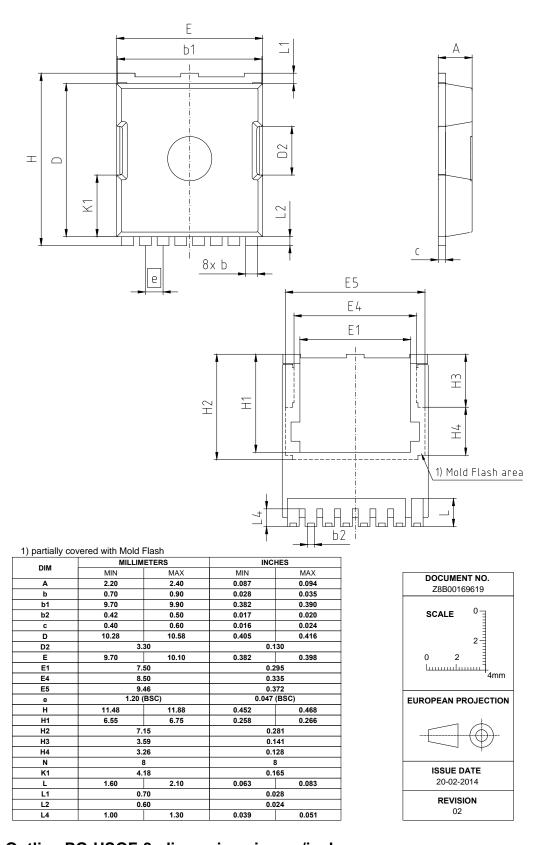


Figure 1 Outline PG-HSOF-8, dimensions in mm/inches

OptiMOS[™] 5 Linear FET, 80 V





Revision History

IPT013N08NM5LF

Revision: 2022-09-19, Rev. 2.1

Previous Revision

1 10110001	Tronder Novicion							
Revision	n Date Subjects (major changes since last revision)							
2.0	2021-08-21	Release of final version						
2.1	2022-09-19	Update Diagram 7						

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to: erratum@infineon.com

Published by Infineon Technologies AG 81726 München, Germany © 2022 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.